



Product Summary

V _{(BR)DSS}	R _{DS(ON)} max	I _D max T _A = +25°C
60V	1.8Ω @ V _{GS} = 5V	470mA
000	2.4Ω @ V _{GS} = 3V	470MA

Description and Applications

DMN61D8L/LVT provides a single component solution for switching inductive loads such as relays, solenoids, and small DC motors in automotive applications, without the need of a freewheeling diode. DMN61D8L/LVT accepts logic level inputs, thus allowing it to be driven by logic gates, inverters, and microcontrollers. It is ideally suited for doors, windows, and antenna relay coils.



Features and Benefits

- Provides a more reliable and robust interface between sensitive logic and DC relay coils.
- Replaces 3-4 discrete components enabling PCB footprint to be reduced.
- Internal active clamp removes the need for external zener diode.
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

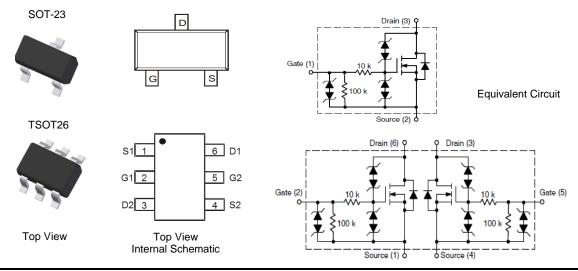
Mechanical Data

Case: SOT23

- Case Material: Molded Plastic, "Green" Molding Compound; UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Annealed over Alloy 42 Leadframe. (Lead-Free Plating). Solderable per MIL-STD-202, Method 208(23)
- Terminal Connections: See Diagram
- Weight: 0.008 grams (Approximate)

Case: TSOT26

- Case Material: Molded Plastic, "Green" Molding Compound; UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- **Terminals Connections: See Diagram**
- Terminals: Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (23)
- Weight: 0.013 grams (Approximate)



Ordering Information (Note 4)

Part Number	Case	Packaging
DMN61D8L-7	SOT23	3,000/Tape & Reel
DMN61D8L-13	SOT23	10,000/Tape & Reel
DMN61D8LVT-7	TSOT26	3,000/Tape & Reel
DMN61D8LVT-13	TSOT26	10,000/Tape & Reel
	2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compli	

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

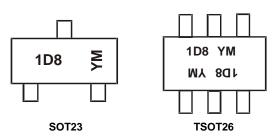
2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.



Marking Information



 $\begin{array}{l} 1D8 = Product \ Type \ Marking \ Code \\ YM = Date \ Code \ Marking \\ Y \ or \ \overline{Y} = Year \ (ex: \ C= 2015) \\ M = Month \ (ex: \ 9 = September) \end{array}$

Date Code Key

Year	2014	4	2015		2016	20	17	2018		2019	2	2020
Code	В		С		D	E		F		G		Н
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	Ν	D

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic			Symbol	Value	Units
Drain-Source Voltage			V _{DSS}	60	V
Gate-Source Voltage			V _{GSS}	±12	V
Continuous Drain Current (Note 6) SOT23	Steady State	T _A = +25°C T _A = +70°C	ID	470 370	mA
Continuous Drain Current (Note 6) TSOT26	Steady State	T _A = +25°C T _A = +70°C	ID	630 500	mA
Maximum Continuous Body Diode Forward Curren	t (Note 6)		I _S	0.5	А
Single Pulse Drain-to-Source Avalanche Energy (for relay coils/inductive loads of 80Ω or higher) (TJ initial = +85°C)			Ez	200	mJ
Peak Power Dissipation, Drain-to-Source (non-repetitive current square pulse 1.0 ms duration) (TJ initial = +85°C)			Ррк	20	W
Load Dump Pulse, Drain-to-Source, RSOURCE = 0.5Ω , T = 300 ms) (for relay coils/inductive loads of 80Ω or higher) (TJ Initial = +85°C)			ELD1	60	V
Inductive Switching Transient 1, Drain-to-Source (Waveform: RSOURCE = 10Ω, T = 2.0 ms) (for relay coils/inductive loads of 80Ω or higher) (TJ Initial = +85°C)			ELD2	100	V
Inductive Switching Transient 2, Drain-to-Source (Waveform: RSOURCE = 4.0Ω , T = 50μ s) (for relay coils/inductive loads of 80Ω or higher) (TJ Initial = $+85^{\circ}$ C)			ELD3	300	V
Reverse Battery, 10 Minutes (Drain-to-Source) (for relay coils/inductive loads of 80Ω or higher)			Rev-Bat	-14	V
Dual Voltage Jump Start, 10 Minutes (Drain-to-Sou	rce)		Dual-Volt	28	V
ESD Human Body Model (HBM)			ESD	4,000	V



Thermal Characteristics (SOT23) (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Units
Total Power Dissipation (Note 5)		PD	390	mW
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	R _{0JA}	321	°C/W
Total Power Dissipation (Note 6)		PD	610	mW
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	R_{\thetaJA}	208	°C/W
Operating and Storage Temperature Range		$T_{J,}T_{STG}$	-55 to +150	°C

Thermal Characteristics (TSOT26) (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Units
Total Power Dissipation (Note 5)		PD	820	mW
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	$R_{ extsf{ heta}JA}$	154	°C/W
Total Power Dissipation (Note 6)		PD	1090	mW
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	R_{\thetaJA}	116	°C/W
Operating and Storage Temperature Range	·	T _J , T _{STG}	-55 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

			L _			
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)						
Drain-Source Breakdown Voltage	BV _{DSS}	60	_		V	$V_{GS} = 0V$, $I_D = 10mA$
Zero Gate Voltage Drain Current	IDSS			50	μA	$V_{DS} = 60V, V_{GS} = 0V$
	1055			0.5	μΛ	$V_{DS} = 12V, V_{GS} = 0V$
Gate-Source Leakage	I _{GSS}		_	±90	μA	$V_{GS} = \pm 5V, V_{DS} = 0V$
	1655			±60	μ/ ($V_{GS} = \pm 3V$, $V_{DS} = 0V$
ON CHARACTERISTICS (Note 7)						
Gate Threshold Voltage	V _{GS(th)}	1.3	—	2.0	V	$V_{DS} = V_{GS}, I_D = 1mA$
Static Drain-Source On-Resistance	R _{DS(ON)}		1.1	1.8	Ω	$V_{GS} = 5V, I_D = 0.15A$
	KDS(ON)		1.4	2.4	32	$V_{GS} = 3V, I_D = 0.15A$
Forward Transfer Admittance	Y _{fs}	80	_		ms	$V_{DS} = 12V, I_D = 0.15A$
Diode Forward Voltage	V _{SD}	_	_	1.2	V	$V_{GS} = 0V, I_S = 0.15A$
DYNAMIC CHARACTERISTICS (Note 8)						
Input Capacitance	Ciss	_	12.9		pF	
Output Capacitance	C _{oss}	_	17		pF	$V_{DS} = 12V, V_{GS} = 0V$ f = 1.0MHz
Reverse Transfer Capacitance	C _{rss}	_	0.84		pF	1 = 1.00012
Total Gate Charge	Qg	_	0.74		nC	
Gate-Source Charge	Q _{gs}	_	0.19		nC	V _{GS} = 5V, V _{DS} = 12V, I _D =150mA
Gate-Drain Charge	Q _{gd}		0.16		nC	
Turn-On Delay Time	t _{D(on)}		131		ns	
Turn-On Rise Time	tr		301		ns	
Turn-Off Delay Time	t _{D(off)}		582		ns	$V_{DD} = 12V, V_{GS} = 5V.$
Turn-Off Fall Time	t _f		440		ns]

Notes: 5. Device mounted on FR-4 PCB, with minimum recommended pad layout.

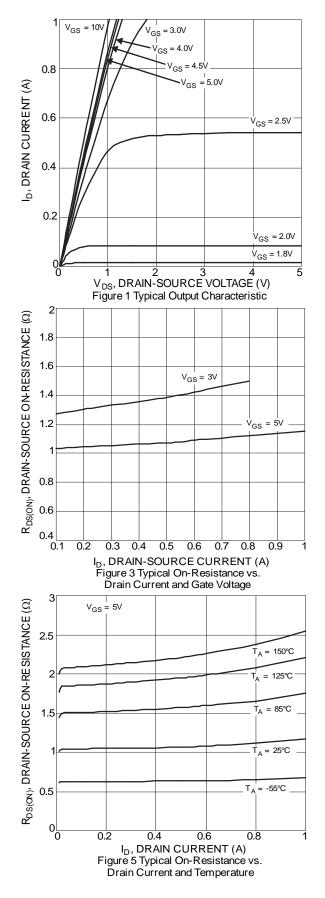
6. Device mounted on 1" x 1" FR-4 PCB with high coverage 2oz. copper, single sided.

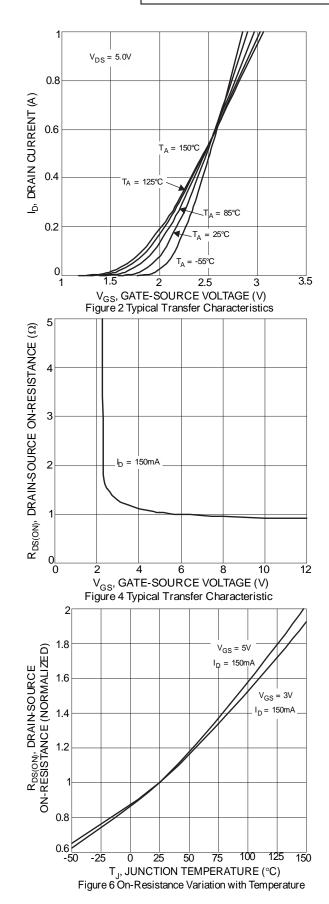
7. Short duration pulse test used to minimize self-heating effect.

8. Guaranteed by design. Not subject to product testing.



DMN61D8L/LVT

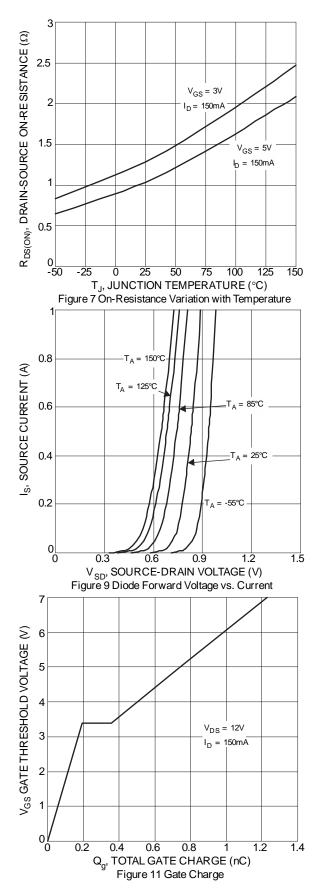


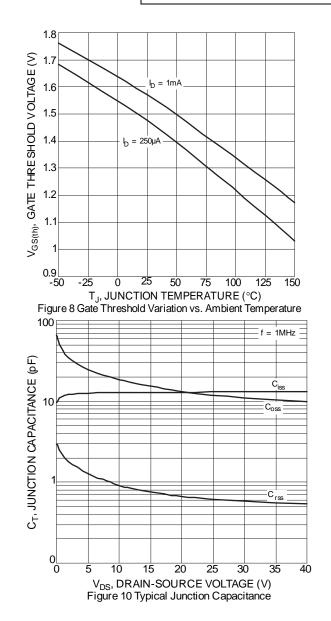


DMN61D8L/LVT Document number: DS37630 Rev. 3 - 2

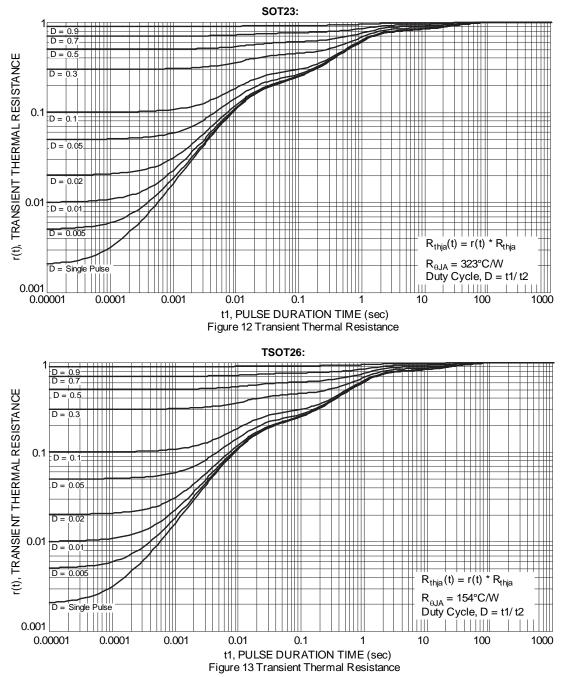
DMN61D8L/LVT









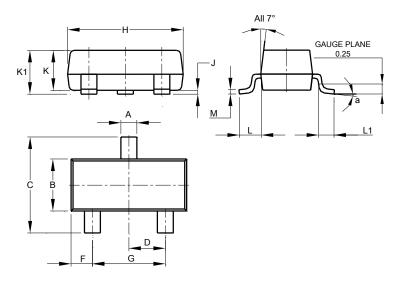




Package Outline Dimensions

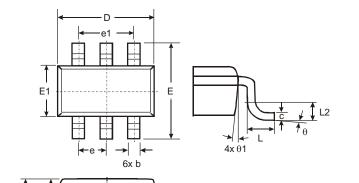
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.

SOT23



	SO	T23			
Dim	Min	Max	Тур		
Α	0.37	0.51	0.40		
В	1.20	1.40	1.30		
С	2.30	2.50	2.40		
D	0.89	1.03	0.915		
F	0.45	0.60	0.535		
G	1.78	2.05	1.83		
Н	2.80	3.00	2.90		
J	0.013	0.10	0.05		
K	0.890	1.00	0.975		
K1	0.903	1.10	1.025		
L	0.45	0.61	0.55		
L1	0.25	0.55	0.40		
М	0.085	0.150	0.110		
α	8°				
All	Dimens	ions in	mm		

TSOT26



	TSO	T26	
Dim	Min	Max	Тур
Α	-	1.00	-
A1	0.01	0.10	_
A2	0.84	0.90	-
D	-	-	2.90
Е	_	-	2.80
E1	_	_	1.60
b	0.30	0.45	-
С	0.12	0.20	-
е	_	_	0.95
e1	_	-	1.90
L	0.30	0.50	
L2	_	_	0.25
θ	0°	8°	4°
θ1	4°	12°	-
aii d	imensi	ons in	mm

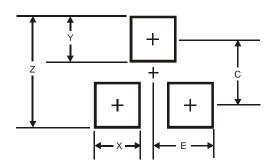
A2



Suggested Pad Layout

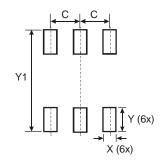
Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.

SOT23



Dimensions	Value (in mm)
Z	2.9
Х	0.8
Y	0.9
С	2.0
E	1.35

TSOT26



Dimensions	Value (in mm)
С	0.950
Х	0.700
Y	1.000
Y1	3.199



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